

SMD thermal fuse for high currents

new



RTS-AC100



RTS-AS500

60VDC · up to 130A · >210°C · PCB, SMT

See below:

[Approvals and Compliances](#)

Description

- Patented surface mount thermal fuse to protect against thermal runaway of power semiconductors such as: MOSFET's, IC's, IGBT's, Triac's, SCR's, etc.
- Highest reliability thanks to complete galvanic separation.

Unique Selling Proposition

- Separates rated voltages up to 60 VDC
- Reflow compatible through mechanical activation procedure
- Galvanic separation happens inside the RTS housing
- Space-saving thanks to integrated shunt

Applications

- Wherever power transistors are used
- Automotive: Cooling fan applications, ABS power steering, PTC heaters, HVAC, Glow plugs, Diesel fuel heaters
- Industrial: Battery Protection, Power supplies, Lighting ballasts, H-Bridge circuits, Motor drivers

Other versions on request

- Thermal protection with integrated fuse
- Thermal protection with customer specific resistance
- Thermal protection with customer specific tripping temperature

Weblinks

[pdf data sheet](#), [html datasheet](#), [General Product Information](#), [Distributor-Stock-Check](#), [Detailed request for product](#), [Landing Page](#), [Video](#)

Technical Data

Rated Voltage	60VDC
Breaking Capacity	400A
Operating current	up to 130A
Mounting	PCB,SMT
Allowable Operation Temperature	-40 °C to +150 °C
Tripping temperature	>210°C
Material: Housing	Plastics
Material: Terminals	Copper alloy, tin-plated
Unit Weight	0.75 g
Storage Conditions	0 °C to 40 °C, max. 70% r.h.
Product Marking	Variant Code, Lot no.
Activation force	Fa = max. 50 N
Activation distance	Sa = 1.1 +0.3/-0.1 mm
Maximum reflow temperature	260 °C (peak)

Soldering Methods	Reflow Soldering Profile
Solderability	JESD22-B102E, Method 1
Resistance to Soldering Heat	JEDEC J-STD-020
Moisture Sensitivity Level	MSL 1, J-STD-020
Damp heat, steady state	MIL-STD-202, Method 103
Thermal Shock	MIL-STD-202, Method 107
Operational Life	MIL-STD-202, Method 108 Condition D
Vibration, High Frequency	MIL-STD-202, Method 204 Condition D
Mechanical Shock	MIL-STD-202, Method 213 Condition B
Resistance to Solvents	MIL-STD-202, Method 215
Temperature Cycling	JESD22, Method JA-104 Condition G
Flame Retardance	AEC-Q200-001 + SAG Specification
Board Flex	AEC-Q200-005
Terminal Strength	AEC-Q200-006

Approvals and Compliances

Detailed information on product approvals, code requirements, usage instructions and detailed test conditions can be looked up in [Details about Approvals](#)

SCHURTER products are designed for use in industrial environments. They have approvals from independent testing bodies according to national and international standards. Products with specific characteristics and requirements such as required in the automotive sector according to IATF 16949, medical technology according to ISO 13485 or in the aerospace industry can be offered exclusively with customer-specific, individual agreements by SCHURTER.




Application standards

Application standards where the product can be used

Organization	Design	Standard	Description
	Designed for applications acc.	IEC/UL 62368-1	IEC 62368-1 includes the basic requirements for safety of audio, video, information technology and office equipment.

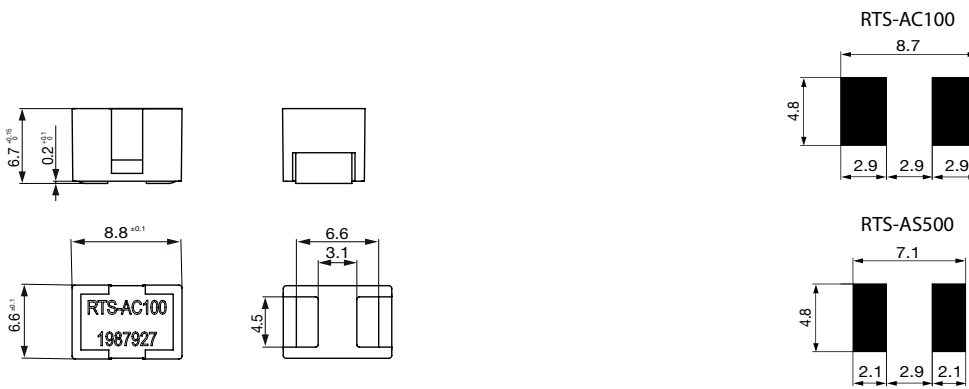
Compliances

The product complies with following Guide Lines

Identification	Details	Initiator	Description
	RoHS	SCHURTER AG	Directive RoHS 2011/65/EU, Amendment (EU) 2015/863
	REACH	SCHURTER AG	On 1 June 2007, Regulation (EC) No 1907/2006 on the Registration, Evaluation, Authorization and Restriction of Chemicals 1 (abbreviated as "REACH") entered into force.
	Automotive	SCHURTER AG	AEC-Q200 is a test standard for passive components used in automotive applications. SCHURTER tests components according to the customer's agreement and is certified according to IATF 16949.

Dimension [mm]

Reflow soldering pads



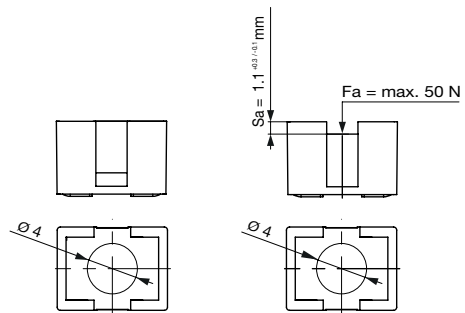
Activation status



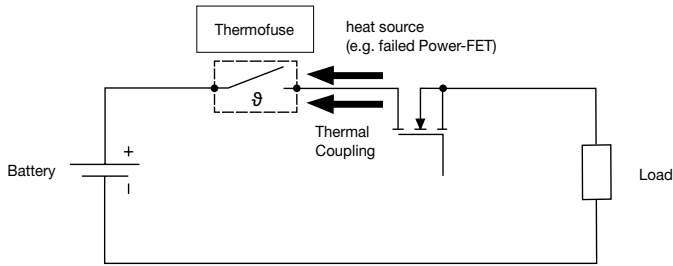
Deactivated:
 Before reflow the activation button should not be manipulated with a force greater 5 newton.

Activated:
 Activation after reflow is necessary for the tripping functionality of the RTS. This activation is done by mechanically pressing the activation button with max 50 newton.

Activation specification

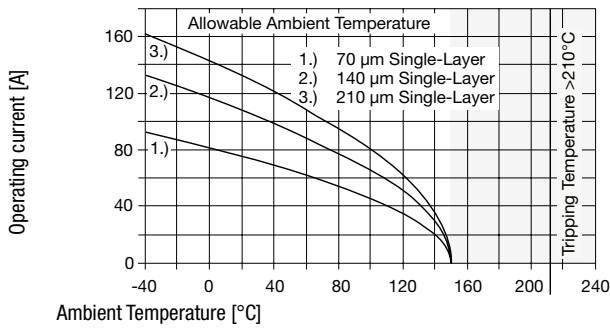


Diagrams

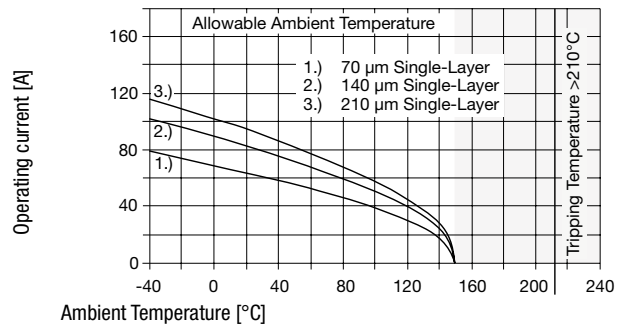


Derating Curves

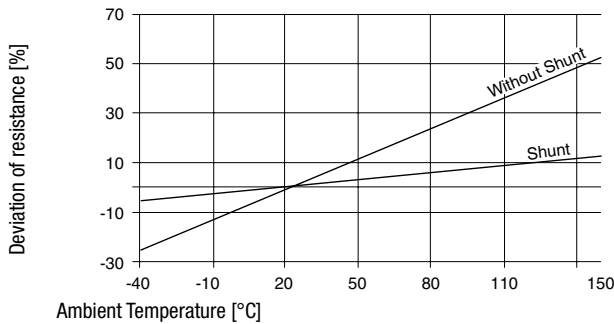
Derating Curve without Shunt



Derating Curve with Shunt



Temperature Uniformity of Resistance



Design-In Principles

- > The RTS should be placed as close as possible to the heat source (power semiconductor).
- > Max. nominal current depends on ambient temperature and on the PCB track implementation (see Derating Curves).
- > The derating curves were generated using a PCB acc. to IEC 60127-4 with a layer width of 20 mm.
- > If operating current is higher than allowed, consider using two RTS in parallel. This doubles the max. current value in the derating curve.

All Variants

Variant Code	Shunt	Cold Resistance [$\mu\Omega$]	Packaging unit [PCS]	Order Number
RTS-AC100		90 - 110	100	3-104-513
RTS-AC100		90 - 110	750	3-104-514
RTS-AS500	●	500 - 580	100	3-119-589
RTS-AS500	●	500 - 580	750	3-119-590

Availability for all products can be searched real-time: <https://www.schurter.com/en/Stock-Check/Stock-Check-SCHURTER>

Breaking Capacity: 400 A @ 24 VDC (L/R < 0.3ms) / 260 A @ 52 VDC (L/R < 0.2ms) / 170 A @ 60 VDC (L/R < 0.1ms)

Packaging Unit

acc. IEC 60286-3 Type 2a

100 St. in 16mm Blister Tape ESD plastic bag
 750 pcs. in 16mm tape on 33cm reel